

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings of claims in the application:

Listing of Claims:

Claim 1 (Currently Amended) [[A]] An integrated thermal dissipation device, comprising:

 a thermal transfer device;

 a standoff press disposed through a bore in a base of the thermal transfer device;

 a screw disposed through the bore in the base of the thermal device; and

 a spring adapted to bias the screw against the thermal transfer device.

Claim 2 (Currently Amended) The integrated thermal dissipation device of claim 1, wherein the screw and the spring bias through to the standoff press.

Claim 3 (Original) The integrated thermal dissipation device of claim 1, wherein the standoff press is press fit to the base of the thermal transfer device.

Claim 4-5 (Cancelled)

Claim 6 (Currently Amended) The integrated thermal dissipation device of claim 3 [[5]], wherein the panel screw is inserted [[to]] through the bore ~~from the top of the thermal transfer device base~~.

Claim 7 (Currently Amended) The integrated thermal dissipation device of claim 1 further comprising a counter-bore, wherein the counter-bore grasps the spring when the thermal transfer device is attached to [[a]] an integrated circuit for reliable thermal performance.

Claim 8 (Currently Amended) The integrated thermal dissipation device of claim 2, wherein the spring is a tension spring ~~and wherein the spring is disposed around the screw~~.

Claim 9 (Currently Amended) The integrated thermal device of claim 2, wherein the ~~bottom~~ threaded end portion of the screw is adapted inside the standoff.

Claim 10 (Currently Amended) An electronic system, comprising:

a circuit board;

a integrated circuit disposed on the circuit board; ~~[[and]]~~

a heat sink positioned in thermal contact with the integrated circuit; and

~~[[a]]~~ an integrated connection apparatus adapted to maintain the heat sink in contact with the integrated circuit, the integrated connection apparatus comprising:

a standoff press disposed through a bore in a base of the heat sink;

a screw disposed through the bore in the base of the heat sink; and

a spring adapted to bias the screw against the heat sink.

Claim 11 (Currently Amended) The electronic system of claim 10, wherein the screw engages the integrated circuit when the ~~bottom~~ threaded end portion of the screw engages the ~~[[top]]~~ base of the heat sink ~~[[base]]~~.

Claim 12 (Currently Amended) The electronic system of claim 11, wherein the standoff press and the spring are hidden in a counter-bore when the screw engages the integrated circuit.

Claim 13 (Currently Amended) The electronic system of claim 10, wherein the screw and the spring bias through to the standoff press.

Claim 14 (Currently Amended) The electronic system of claim 10, wherein the standoff press is press fit to the base of the heat sink.

Claim 15 (Cancelled)

Claim 16 (Currently Amended) The electronic system of claim 14, wherein the screw is inserted ~~[[to]]~~ through the bore ~~from the top of the heat sink base~~.

Claim 17 (Currently Amended) The electronic system of claim 10 further comprising a counter-bore, wherein the counter-bore grasps the spring when the heat sink is attached to the integrated circuit for ~~reliable thermal performance~~.

Claim 18 (Currently Amended) The electronic system of claim 10, wherein the ~~bottom~~ threaded end portion of the screw is adapted inside the standoff press.

Claim 19 (Currently Amended) An apparatus comprising:

a standoff press disposed through ~~the bottom of~~ a bore in a ~~support~~ base;

a screw disposed through ~~the top of~~ the bore in the ~~support~~ base; and

a spring adapted to bias the screw against a device to be retained,

wherein the screw and the spring engage the standoff press to attach the device to the ~~support~~ base.

Claim 20 (Currently Amended) The apparatus of claim 19 wherein the standoff press is ~~press~~ fit to the ~~support~~ base.

Claim 21 (Currently Amended) The apparatus of claim 19 wherein the ~~bottom~~ threaded end portion of the screw is adapted inside the standoff press.